

## **AMENDMENTS TO THE SPECIFICATION**

In accordance with 37 C.F.R. §1.121(b), please amend the specification of the application as indicated in marked-up form below, where additions are underlined, deletions are struck through, and new paragraphs are presented without markings.

**Please replace the title of the invention with the following:**

SEMICONDUCTOR COMPONENT COMPRISING LEADFRAME, SEMICONDUCTOR  
CHIP, AND INTEGRATED PASSIVE COMPONENT IN VERTICAL RELATIONSHIP TO  
EACH OTHER